LDO Regulator, 300 mA, Low Dropout Voltage, Ultra Low Noise, High PSRR with Power Good

NCP164

The NCP164 is a 300 mA LDO, next generation of high PSRR, ultra-low noise and low dropout regulators with Power Good open collector output. Designed to meet the requirements of RF and sensitive analog circuits, the NCP164 device provides ultra-low noise, high PSRR and low quiescent current. The device also offer excellent load/line transients. The NCP164 is designed to work with a 1 μ F input and a 1 μ F output ceramic capacitor. It is available in industry standard TSOP-5 and WDFN6 0.65P, 2 mm x 2 mm.

Features

- Operating Input Voltage Range: 1.6 V to 5.5 V
- Available in Fixed Voltage Option: 1.2 V to 5 V
- Adjustable Version Reference Voltage: 1.1 V
- ±2% Accuracy Over Load and Temperature
- Ultra Low Quiescent Current Typ. 30 µA
- Standby Current: Typ. 0.1 µA
- Very Low Dropout: 110 mV at 300 mA for 3.3 V Variant
- Ultra High PSRR: Typ. 85 dB at 10 mA, f = 1 kHz
- Ultra Low Noise: 9 µV_{RMS} (Fixed Version)
- Stable with a 1 µF Small Case Size Ceramic Capacitors
- Available in TSOP–5 3 mm x 1.5 mm x 1 mm CASE 483
 WDFN6 2 mm x 2 mm x 0.75 mm CASE 511BR
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Communication Systems
- In-Vehicle Networking
- Telematics, Infotainment and Clusters
- General Purpose Automotive

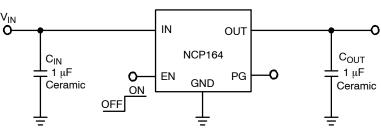
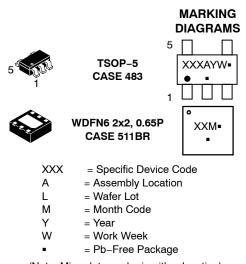


Figure 1. Typical Application Schematic



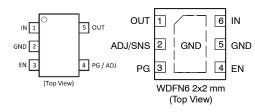
ON Semiconductor®

www.onsemi.com



(Note: Microdot may be in either location)





ORDERING INFORMATION

See detailed ordering and shipping information on page 8 of this data sheet.

Table 1. PIN FUNCTION DESCRIPTION

Pin No. TSOP-5	Pin No. WDFN6	Pin Name	Description
1	6	IN	Input voltage supply pin
5	1	OUT	Regulated output voltage. The output should be bypassed with small 1 μF ceramic capacitor
3	4	EN	Chip enable: Applying V _{EN} < 0.2 V disables the regulator, Pulling V _{EN} > 0.7 V enables the LDO
4 / -	3	PG	Power Good, open collector. Use 10 k Ω to 100 k Ω pull–up resistor connected to output or input voltage
2	5	GND	Common ground connection
- / 4	2	ADJ	Adjustable output feedback pin (for adjustable version only)
-	2	SNS	Sense feedback pin. Must be connected to OUT pin on PCB (for fixed versions only)
-	-	N/C	Not connected, pin can be tied to ground plane for better power dissipation
-	EPAD	EPAD	Expose pad should be tied to ground plane for better power dissipation

Table 2. ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Input Voltage (Note 1)	V _{IN}	–0.3 to 6	V
Output Voltage	V _{OUT}	–0.3 to V _{IN} +0.3, max. 6	V
Chip Enable Input	V _{CE}	–0.3 to 6	V
Power Good Voltage	V _{PG}	–0.3 to 6	V
Power Good Current	I _{PG}	30	mA
Output Short Circuit Duration	tsc	unlimited	s
Maximum Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	–55 to 150	°C
ESD Capability, Human Body Model (Note 2)	ESD _{HBM}	2000	V
ESD Capability, Charged Device Model (Note 2)	ESD _{CDM}	1000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.
Refer to ELECTRICAL CHARACTERISTIS and APPLICATION INFORMATION for Safe Operating Area.
This device series incorporates ESD protection and is tested by the following methods: ESD Human Body Model tested per AEC-Q100-002 (EIA/JESD22-A114) ESD Charged Device Model tested per EIA/JESD22-C101, Field Induced Charge Model

Table 3. THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
THERMAL CHARACTERISTICS, TSOP-5 PACKAGE			•
Thermal Resistance, Junction-to-Ambient (Note 3)	$R_{ hetaJA}$	158	°C/W
Thermal Resistance, Junction-to-Case (top)	R _{θJC(top)}	155	°C/W
Thermal Resistance, Junction-to-Case (bottom) (Note 4)	R _{θJC(bot)}	102	°C/W
Thermal Resistance, Junction-to-Board	$R_{ heta JB}$	197	°C/W
Characterization Parameter, Junction-to-Top	Ψ_{JT}	40	°C/W
Characterization Parameter, Junction-to-Board	Ψ_{JB}	82	°C/W
THERMAL CHARACTERISTICS, WDFN6-2X2, 0.65 PITCH PACKAGE			
Thermal Resistance, Junction-to-Ambient (Note 3)	$R_{ hetaJA}$	51	°C/W
Thermal Resistance, Junction-to-Case (top)	R _{0JC(top)}	142	°C/W
Thermal Resistance, Junction-to-Case (bottom) (Note 4)	R _{θJC(bot)}	2.0	°C/W
Thermal Resistance, Junction-to-Board	$R_{ heta JB}$	117	°C/W
Characterization Parameter, Junction-to-Top	Ψ_{JT}	1.9	°C/W

Characterization Parameter, Junction-to-Board Ψ_{JB} 7.7 °C/W 3. The junction-to-ambient thermal resistance under natural convection is obtained in a simulation on a high-K board, following the JEDEC51.7

guidelines with assumptions as above, in an environment described in JESD51–2a. 4. The junction–to–case (bottom) thermal resistance is obtained by simulating a cold plate test on the IC exposed pad. Test description can be found in the ANSI SEMI standard G30-88.

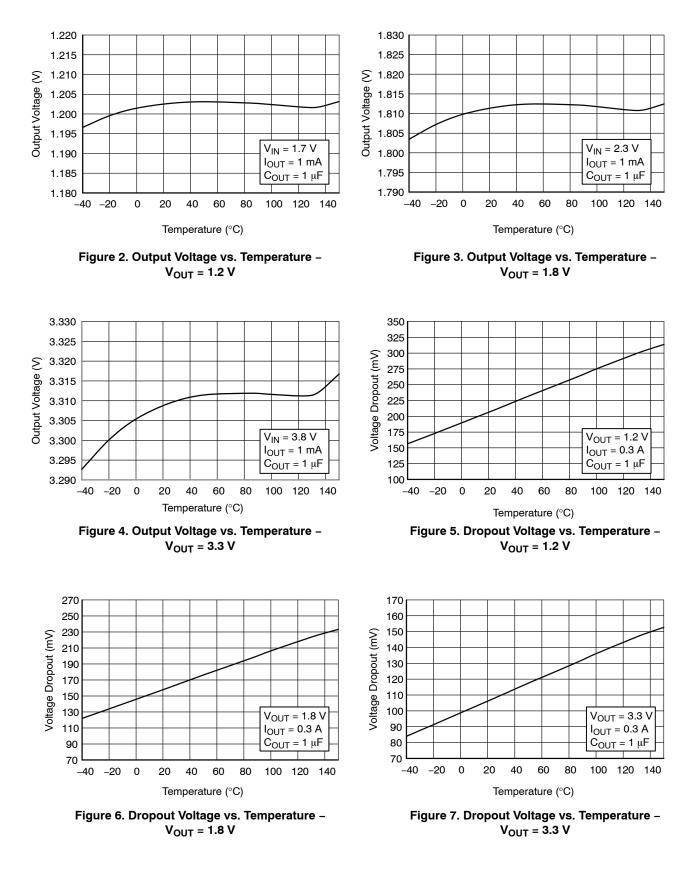
Table 4. ELECTRICAL CHARACTERISTICS	$(-40^{\circ}C \le T_J \le 150^{\circ}C; V_{IN} = V_{OUT(NOM)} + 0.5 \text{ V}; I_{OUT} = 1 \text{ mA}, C_{IN} = C_{OUT}$
= 1 µF, V _{EN} = V _{IN} , unless otherwise noted. Typical va	lues are at $T_J = +25^{\circ}C$ (Note 5))

Parameter	Test Conditions		Symbol	Min	Тур	Max	Unit
Operating Input Voltage			V _{IN}	1.6		5.5	V
Output Voltage Accuracy	$\label{eq:VIN} \begin{array}{l} V_{IN} = V_{OUT(NOM)} + 0.5 \text{ V to } 5.0 \text{ V}, \\ 0.1 \text{ mA} \leq I_{OUT} \leq 300 \text{ mA} \end{array}$		V _{OUT}	-2		+2	%
Reference Voltage (Adjustable Ver. ADJ pin connected to OUT)	V _{IN} = 1.6 \ 0.1 mA ≤ I _{OU}	/ to 5.0 V, _{JT} ≤ 300 mA	V _{ADJ}	1.078	1.1	1.122	V
Line Regulation	V _{OUT(NOM)} + 0.5	$5 \text{ V} \le \text{V}_{\text{IN}} \le 5.0 \text{ V}$	Line _{Reg}		0.5		mV/V
Load Regulation	I _{OUT} = 1 mA	to 300 mA	Load _{Reg}		2		mV
Dropout Voltage (Note 6)	l _{OUT} = 300 mA	V _{OUT(NOM)} = 1.5 V	V _{DO}		170 295	295	mV
TSOP-5, WDFN6		V _{OUT(NOM)} = 1.8 V	1		155	255	
		V _{OUT(NOM)} = 2.5 V			125	200	1
		V _{OUT(NOM)} = 2.8 V			115	185	1
		V _{OUT(NOM)} = 3.0 V	-		113	177	
		V _{OUT(NOM)} = 3.3 V			110	170	
		V _{OUT(NOM)} = 4.5 V			95	135	
Output Current Limit	V _{OUT} = 90%	V _{OUT(NOM)}	I _{CL}	350	560		mA
Short Circuit Current	V _{OUT} = 0 V		I _{SC}		580		
Quiescent Current	l _{OUT} = 0 mA		Ι _Q		30	40	μΑ
Shutdown Current	$V_{EN} \le 0.4 V$		I _{DIS}		0.01	1.5	μA
EN Pin Threshold Voltage	EN Input Voltage "H"		V _{ENH}	0.7			V
	EN Input Voltage "L"		V _{ENL}			0.2	
EN Pull Down Current	V _{EN} =	V _{EN} = 5.0 V			0.2	0.6	μA
Power Good Threshold Voltage	Output Voltage Raising		V _{PGUP}		95		%
	Output Volt	V _{PGDW}		90			
Power Good Output Voltage Low	I _{PG} = 5 mA,	Open drain	V _{PGLO}			0.3	V
Turn–On Time (Note 7)	C _{OUT} = 1 μF, From assertion of V _{EN} to V _{OUT} = 95% V _{OUT(NOM)}				120		μs
Power Supply Rejection Ratio	V _{OUT(NOM)} = 3.3 V,	f = 100 Hz	P _{SRR}		83		dB
(Note 7)	$I_{OUT} = 10 \text{ mA}$	f = 1 kHz			85		
		f = 10 kHz			80	1	
		f = 100 kHz			61		
Output Voltage Noise (Fixed Ver.)	f = 10 Hz to 100 kHz	I _{OUT} = 10 mA	V _N		9		μV _{RM}
Thermal Shutdown Threshold	Temperature rising		T _{SDH}		165		°C
(Note 7)	Temperature	T _{HYST}		15		°C	
Active output discharge resistance	V _{EN} < 0.2 V, Version A only		R _{DIS}	1	260	1	Ω

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Performance guaranteed over the indicated operating temperature range by design and/or characterization.

Production tested at T_J = T_A = 25°C.
6. Low duty cycle pulse techniques are used during the testing to maintain the junction temperature as close to ambient as possible. Dropout voltage is characterized when V_{OUT} falls 3% below V_{OUT(NOM)}. 7. Guaranteed by design and characterization.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS (continued)

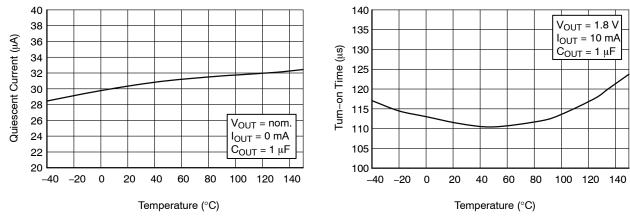


Figure 8. Quiescent Current va Temperature



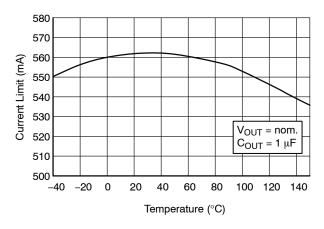


Figure 10. Current Limit vs. Temperature

V_{OUT} raising to nominal

96,0

95,0

^oower Good Thresholds (%)

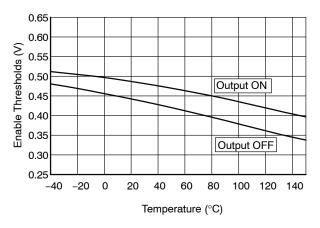
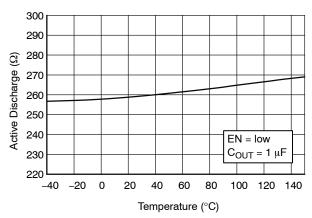
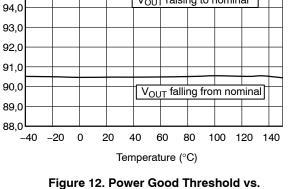


Figure 11. Enable Thresholds vs Temperature

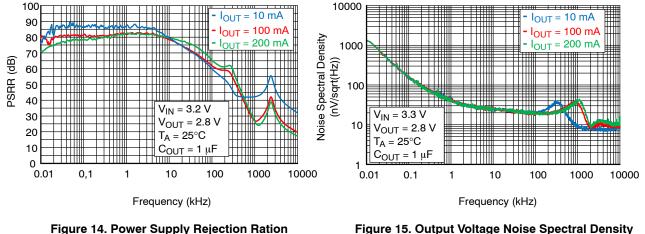






Temperature

TYPICAL CHARACTERISTICS (continued)



for $V_{OUT} = 2.8 V$, $C_{OUT} = 1 \mu F$

Figure 15. Output Voltage Noise Spectral Density for V_{OUT} = 2.8 V, C_{OUT} = 1 μ F

APPLICATIONS INFORMATION

The NCP164 is the member of new family of high output current and low dropout regulators which delivers low quiescent and ground current consumption, good noise and power supply ripple rejection ratio performance. The NCP164 incorporates EN pin and power good output for simple controlling by MCU or logic. Standard features include current limiting, soft–start feature and thermal protection.

Input Decoupling (CIN)

It is recommended to connect at least 1 μ F ceramic X5R or X7R capacitor between IN and GND pin of the device. This capacitor will provide a low impedance path for any unwanted AC signals or noise superimposed onto constant input voltage. The good input capacitor will limit the influence of input trace inductances and source resistance during sudden load current changes. Higher capacitance and lower ESR capacitors will improve the overall line transient response.

Output Decoupling (COUT)

The NCP164 does not require a minimum Equivalent Series Resistance (ESR) for the output capacitor. The device is designed to be stable with standard ceramics capacitors with values of 1 μ F or greater. The X5R and X7R types have the lowest capacitance variations over temperature thus they are recommended.

Power Good Output Connection

The NCP164 include Power Good functionality for better interfacing to MCU system. Power Good output is open collector type, capable to sink up to 10 mA. Recommended operating current is between 10 μ A and 1 mA to obtain low

saturation voltage. External pull-up resistor can be connected to any voltage up to 5.0 V (please see Absolute Maximum Ratings table).

Power Dissipation and Heat Sinking

The maximum power dissipation supported by the device is dependent upon board design and layout. Mounting pad configuration on the PCB, the board material, and the ambient temperature affect the rate of junction temperature rise for the part. For reliable operation junction temperature should be limited to +125°C, however device is capable to work up to junction temperature +150°C. The maximum power dissipation the NCP164 can handle is given by:

$$P_{D(MAX)} = \frac{\left[T_{J(MAX)} - T_{A}\right]}{R_{\theta JA}}$$
(eq. 1)

The power dissipated by the NCP164 for given application conditions can be calculated from the following equations:

$$\mathsf{P}_\mathsf{D} \approx \mathsf{V}_\mathsf{IN}(\mathsf{I}_\mathsf{GND}(\mathsf{I}_\mathsf{OUT})) \, + \, \mathsf{I}_\mathsf{OUT} \, (\mathsf{V}_\mathsf{IN} - \mathsf{V}_\mathsf{OUT}) \qquad (\text{eq. 2})$$

or

$$V_{IN(MAX)} \approx \frac{P_{D(MAX)} + (V_{OUT} \times I_{OUT})}{I_{OUT} + I_{GND}}$$
 (eq. 3)

Hints

VIN and GND printed circuit board traces should be as wide as possible. When the impedance of these traces is high, there is a chance to pick up noise or cause the regulator to malfunction. Place external components, especially the output capacitor, as close as possible to the NCP164, and make traces as short as possible.

Adjustable Version

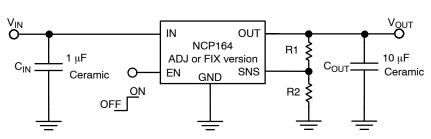
Not only adjustable version, but also any fixed version can be used to create adjustable voltage, where original fixed voltage becomes reference voltage for resistor divider and feedback loop. Output voltage can be equal or higher than original fixed option, while possible range is from 1.1 V up to 5 V. Figure 16 shows how to add external resistors to increase output voltage above fixed value.

 $V_{OUT} = V_{FIX} \times (1 + R1/R2)$

Output voltage is then given by equation

where V_{FIX} is voltage of original fixed version (from 1.2 V up to 5 V) or adjustable version (1.1 V). Do not operate the device at output voltage about 5.2 V, as device can be damaged.

In order to avoid influence of current flowing into SNS pin to output voltage accuracy (SNS current varies with voltage option and temperature, typical value is 300 nA) it is recommended to use values of R1 and R2 below 500 k Ω .



(eq. 4)

Figure 16. Adjustable Variant Application

Please note that output noise is amplified by V_{OUT} / V_{FIX} ratio. For example, if original 1.2 V fixed variant is used to create 3.6 V output voltage, output noise is increased 3.6 / 1.2 = 3 times and real value will be $3 \times 9 \,\mu Vrms = 27 \,\mu Vrms$. For noise sensitive applications it is recommended to use as

high fixed variant as possible – for example in case above it is better to use 3.3 V fixed variant to create 3.6 V output voltage, as output noise will be amplified only $3.6 / 3.3 = 1.09 \times (9.8 \,\mu\text{Vrms})$.

Device Part No.	Voltage Variant	Marking	Package Option	Package	Shipping †
NCP164ASN180T1G	1.8 V	AJ	N/A	TSOP5 (Pb–Free)	3000 / Tape & Reel
NCP164ASN280T1G	2.8 V	AK	N/A	TSOP5 (Pb–Free)	3000 / Tape & Reel
NCP164ASN330T1G	3.3 V	AL	N/A	TSOP5 (Pb–Free)	3000 / Tape & Reel
NCP164ASNADJT1G	ADJ	A6	N/A	TSOP5 (Pb–Free)	3000 / Tape & Reel
NCP164AMT120TAG	1.2 V	CA	Non-Wettable	WDFN6 2 x 2 (Pb–Free)	3000 / Tape & Reel
NCP164AMT180TAG	1.8 V	CJ	Non-Wettable	WDFN6 2 x 2 (Pb–Free)	3000 / Tape & Reel
NCP164AMT280TAG	2.8 V	СК	Non-Wettable	WDFN6 2 x 2 (Pb–Free)	3000 / Tape & Reel
NCP164AMT330TAG	3.3 V	CL	Non-Wettable	WDFN6 2 x 2 (Pb–Free)	3000 / Tape & Reel
NCP164AMTADJTAG	ADJ	C2	Non-Wettable	WDFN6 2 x 2 (Pb-Free)	3000 / Tape & Reel

ORDERING INFORMATION

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

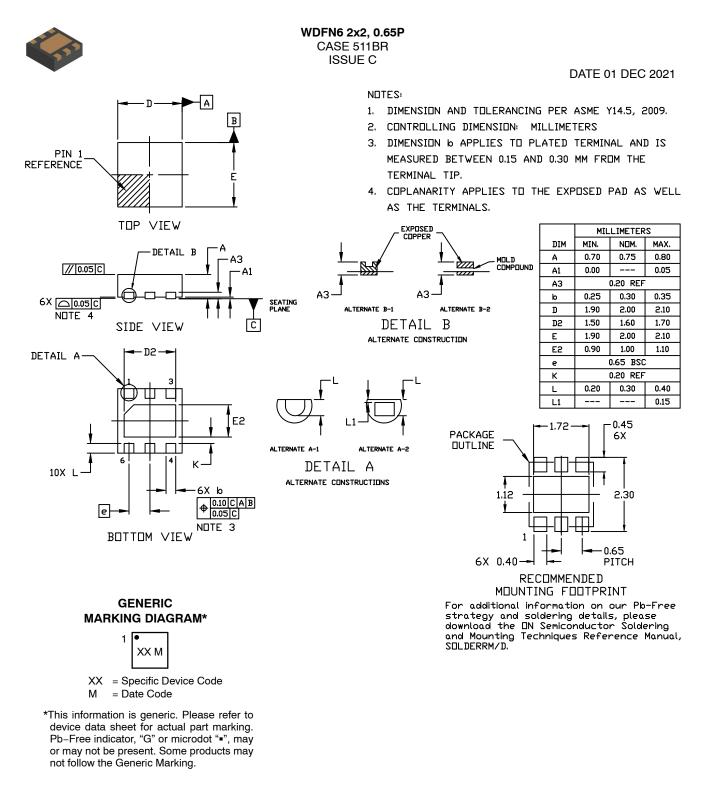




DOCUMENT NUMBER:	98ARB18753C Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.					
DESCRIPTION:	TSOP-5	PAGE 1 OF 1				
ON Semiconductor and (III) are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. ON Semiconductor does not convey any license under its patent rights nor the rights of others.						

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

onsemi



DOCUMENT NUMBER:	98AON55829E Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.						
DESCRIPTION:	WDFN6 2X2, 0.65P		PAGE 1 OF 1				

onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and calcular performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

TECHNICAL SUPPORT

onsemi Website: www.onsemi.com

Email Requests to: orderlit@onsemi.com

North American Technical Support: Voice Mail: 1 800-282-9855 Toll Free USA/Canada Phone: 011 421 33 790 2910

Europe, Middle East and Africa Technical Support: Phone: 00421 33 790 2910 For additional information, please contact your local Sales Representative